



Material Content Data Sheet



Sales Product Name		IPAN70R750P7S		Issued		31. July 2018		
MA#		MA002555316						
Package		PG-TO220-3-319		Weight*		2202.86 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.365	0.06	0.06	620	620
leadframe	inorganic material	phosphorus	7723-14-0	0.345	0.02		156	
	non noble metal	iron	7439-89-6	1.149	0.05		521	
	non noble metal	copper	7440-50-8	1147.227	52.08	52.15	520790	521467
	non noble metal	aluminium	7429-90-5	0.245	0.01	0.01	111	111
wire	non noble metal	aluminium	7429-90-5	0.245	0.01	0.01	111	111
encapsulation	organic material	carbon black	1333-86-4	10.435	0.47		4737	
	plastics	epoxy resin	-	167.156	7.59		75881	
	inorganic material	silicondioxide	60676-86-0	866.594	39.34	47.40	393395	474013
leadfinish	non noble metal	tin	7440-31-5	7.148	0.32	0.32	3245	3245
solder	non noble metal	antimony	7440-36-0	0.120	0.01		54	
	noble metal	silver	7440-22-4	0.300	0.01		136	
	non noble metal	tin	7440-31-5	0.779	0.04	0.06	354	544
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com